

# Chip Beads (2518127007Y3)



Part Number: 2518127007Y3

#### MULTI- LAYER CHIP BEAD

### Part Number System: Example 2512063017Y1

25	1206	301	7	Y	1	
Chip	Package	Impedance	Packaging	Material	Curren	t Code
Bead	Size	Code	Code	Code	0 < 1.	0A
Code	Code	300 A	6= Bulk Packed	Y = Standard Signal Speed	1 ≥1.	0A <2.0A
		7=	Taped and Reeled 7" Reel	Z = High Signal Speed	3 ≥ 3.	0A <4.0A
		8=	Taped and Reeled 13" Reel	H = GHz Speed	ET	C

Fair- Rite offers a broad selection of cost effective multi- layer chip beads to suppress conducted EMI signals. Chip beads can be used in an array of devices such as cellular phones, computers, laptops, pagers, etc. The small package sizes accommodate automated placements and allow for a dense packaging of circuit boards.

Chip Beads are available in standard, high and GHz signal speeds.

#### Recommended Soldering Profile

#### Packaging Options:

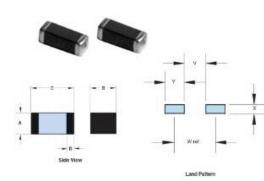
- All multi- layer chip beads are supplied taped and reeled, if required bulk packed chip beads can be provided.

The suggested land patterns are in accordance to the latest revision of IPC-7351.

Weight: 0.09 (g)

Packag	ge Size	: 1812 (453)	2)						
Dim	mm	mm tol	nominal inch	inch misc.					
А	1.5	±0.20	0.059	_					
В	3.2	±0.20	0.126	_					
С	4.5	±0.20	0.177	_					
D	0.7	±0.30	0.028	_					
Land F	Land Patterns								
V		W	Х	Y	Ζ				
2.00 3.90		3.90	3.40	1.90					
(0.079)	")	(0.154")	(0.134")	(0.075")					

Reel Informat	tion			
Tape Width mm	Pitch mm	Parts 7" Reel	Parts 13" Reel	Parts 14" Reel
12	8	1000	5000	_

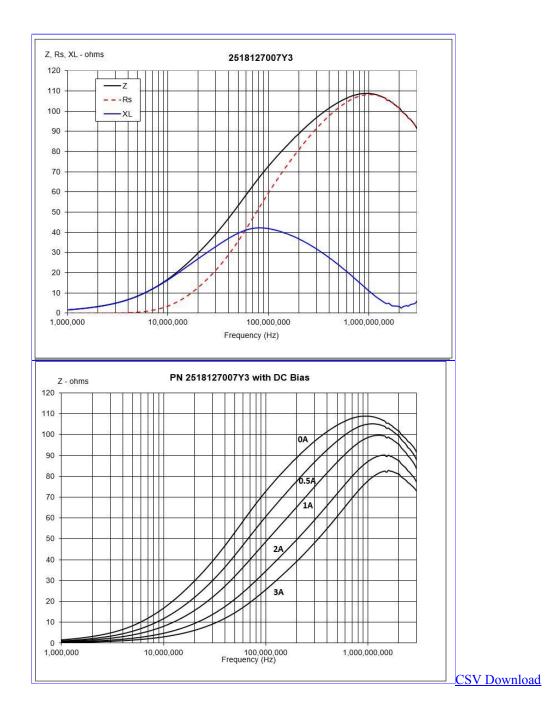


Pkg. Size						Land Patterns					Reel Int	<b>Reel Information</b>	
	A	8	C	D	WL (g)	×	W (ref)	×	Y	Tape Width mm	mm	Part 7" Ree	
0402 (1005)		0.5±0.05 0.020	1.0±0.05 0.040	0.25±0.15 0.010	0.002	0.40 0.016	1.30 0.051	0.70 0.028	0.90 0.035	8	4	1000	
0603 (1608)	0.8±0.15 0.031	0.8±0.15 0.031	1.6±0.15 0.063	0.4±0.2 0.016	0.006	0.60 0.024	1.70 0.067	1.00 0.039	1.10 0.043	8	4	4000	
0805 (2012)	0.9±0.2 0.035	1.25±0.2 0.049	2.0±0.2 0.079	0.5±0.3 0.020	0.01	0.60 0.024	1.90 0.075	1.50 0.059	1.30 0.051	8	4	4000	
1206 (3216)	1.1±0.2 0.043	1.6±0.2 0.063	3.2±0.2 0.126	0.7±0.3 0.028	0.03	1.20 0.047	2.80 0.110	1.80 0.071	1.60 0.063	8	4	3000	
1806 (4516)	1.6±0.2 0.063	1.6±0.2 0.063	4.5±0.2 0.177	0.7±0.3 0.028	0.06	2.00 0.079	3.90 0.154	1.80 0.071	1.90 0.075	12	8	2000	
1812 (4532)	1.5±0.2 0.059	3.2±0.2 0.126	4.5±0.2 0.177	0.7±0.3 0.028	0.09	2.00 0.079	3.90 0.154	3.40 0.134	1.90 0.075	12	8	1000	

## **Chart Legend** + Test frequency

r	
Typical Impe	edance $(\Omega)$
50 MHz	53
$100 \text{ MHz}^+$	70 ±25%
500 MHz	104
$1000 \text{ MHz}^+$	-
Electrical Pro	operties
Max DCR	0.04
(Ω)	0.04
Max Current	3000
(mA)	5000

The impedance values listed are typical values. The nominal impedance with a +/-25% tolerance is specified for the + marked 100 MHz. Chip beads are measured for impedance on the HP 4291A and fixture HP 16192A. Chip beads are 100% tested for impedance and dc resistance.



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